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July 1999 Revised December 2013

#### 74VCX86

# Low Voltage Quad 2-Input Exclusive-OR Gate with 3.6V Tolerant Inputs and Outputs

#### **General Description**

The VCX86 contains four 2-input exclusive OR gates. This product is designed for low voltage (1.2V to 3.6V)  $V_{CC}$  applications with I/O compatibility up to 3.6V

The 74VCX86 is fabricated with an advanced CMOS technology to achieve high-speed operation while maintaining low CMOS power dissipation.

#### **Features**

- 1.2V to 3.6V V<sub>CC</sub> supply operation
- 3.6V tolerant inputs and outputs
- t<sub>P</sub>r

3.0 ns max for 3.0V to 3.6V  $V_{\rm CC}$ 

- Power-off high impedance inputs and outputs
- Static Drive (I<sub>OH</sub>/I<sub>OL</sub>) ±24 mA @ 3.0V V<sub>CC</sub>
- Uses proprietary noise/EMI reduction circuitr
- Latchup performance exceeds JEDEC 78 conditions
- ESD performance:

Human body model > 2000V Machine model > 250V

■ Leadless Pb-Free DQFN package

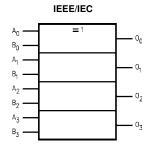
### **Ordering Code:**

Order Number	Package Number	Package Description		
74VCX86M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow		
74VCX86BQX (Note 1)		Pb-Free 14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JE MO-241, 2.5 x 3.0mm		
74VCX86MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide		

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code. Pb-Free package per JEDEC J-STD-020B.

Note 1: DQFN package available in Tape and Reel only.

## **Logic Symbol**



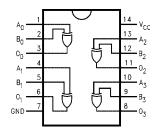
## **Pin Descriptions**

Pin Names	Description
A <sub>n</sub> , B <sub>n</sub>	Inputs
O <sub>n</sub>	Outputs
DAP	No Connect

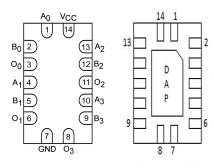
Note: DAP (Die Attach Pad)

## **Connection Diagrams**

Pin Assignments for SOIC and TSSOP



Pad Assignments for DQFN



(Top View)

(Bottom View)

#### **Absolute Maximum Ratings**(Note 2)

-0.5V to +4.6V Supply Voltage (V<sub>CC</sub>) DC Input Voltage (V<sub>I</sub>) -0.5V to +4.6V Output Voltage (V<sub>O</sub>) HIGH or LOW State (Note 3) -0.5V to  $V_{CC} + 0.5V$  $V_{CC} = 0V$ -0.5V to +4.6VDC Input Diode Current ( $I_{IK}$ )  $V_I < 0V$ -50 mA DC Output Diode Current (I<sub>OK</sub>)  $V_{O} < 0V$ -50 mA  $V_O > V_{CC}$ +50 mA DC Output Source/Sink Current  $(I_{OH}/I_{OL})$  $\pm 50 \text{ mA}$ DC V<sub>CC</sub> or GND Current per Supply Pin (I<sub>CC</sub> or Ground) ±100 mA

-65°C to +150°C

## Recommended Operating Conditions (Note 4)

Power Supply 1.2V to 3.6V Operating -0.3V to +3.6VInput Voltage Output Voltage (V<sub>O</sub>) HIGH or LOW State 0V to  $V_{CC}$ Output Current in I<sub>OH</sub>/I<sub>OL</sub>  $V_{CC} = 3.0V \text{ to } 3.6V$ ±24 mA  $V_{CC} = 2.3V \text{ to } 2.7V$  $\pm 18~mA$  $V_{CC} = 1.65V \text{ to } 2.3V$ ±6 mA  $V_{CC} = 1.4V \text{ to } 1.6V$ ±2 mA ±100 μA  $V_{CC} = 1.2V$ Free Air Operating Temperature (T<sub>A</sub>) -40°C to +85°C Minimum Input Edge Rate ( $\Delta t/\Delta V$ )

 $V_{IN} = 0.8V \text{ to } 2.0V, V_{CC} = 3.0V$  10 ns/V

Note 2: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 3: I<sub>O</sub> Absolute Maximum Rating must be observed.

Note 4: Floating or unused inputs must be held HIGH or LOW.

### **DC Electrical Characteristics**

Storage Temperature Range  $(T_{STG})$ 

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Max	Units
V <sub>IH</sub>	HIGH Level Input Voltage		2.7 - 3.6	2.0		
			2.3 - 2.7	1.6		
			1.65 - 2.3	$0.65 \times V_{CC}$		V
			1.4 - 1.6	$0.65 \times V_{CC}$		
			1.2	$0.65 \times V_{CC}$		
V <sub>IL</sub>	LOW Level Input Voltage		2.7 - 3.6		0.8	
			2.3 - 2.7		0.7	
			1.65 - 2.3		$0.35 \times V_{CC}$	V
			1.4 - 1.6		$0.35 \times V_{CC}$	
			1.2			
V <sub>OH</sub>	HIGH Level Output Voltage	$I_{OH} = -100 \mu A$	2.7 - 3.6	V <sub>CC</sub> - 0.2		
		$I_{OH} = -12 \text{ mA}$	2.7	2.2		
		$I_{OH} = -18 \text{ mA}$	3.0	2.4		
		$I_{OH} = -24 \text{ mA}$	3.0	2.2		
		$I_{OH} = -100 \mu A$	2.3 - 2.7	V <sub>CC</sub> - 0.2		
		$I_{OH} = -6 \text{ mA}$	2.3	2.0		
		$I_{OH} = -12 \text{ mA}$	2.3	1.8		V
		$I_{OH} = -18 \text{ mA}$	2.3	1.7		
		$I_{OH} = -100 \mu A$	1.65 - 2.3	V <sub>CC</sub> - 0.2		
		$I_{OH} = -6 \text{ mA}$	1.65	1.25		
		$I_{OH} = -100 \mu A$	1.4 - 1.6	V <sub>CC</sub> - 0.2		
		$I_{OH} = -2 \text{ mA}$	1.4	1.05		
		$I_{OH} = -100 \mu A$	1.2	V <sub>CC</sub> - 0.2		

## DC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Max	Units
V <sub>OL</sub>	LOW Level Output Voltage	$I_{OL} = 100 \mu A$	2.7 - 3.6		0.2	
		$I_{OL} = 12 \text{ mA}$	2.7		0.4	
		I <sub>OL</sub> = 18 mA	3.0		0.4	
		$I_{OL} = 24 \text{ mA}$	3.0		0.55	
		$I_{OL} = 100 \mu A$	2.3 - 2.7		0.2	
		$I_{OL} = 12 \text{ mA}$	2.3		0.4	V
		$I_{OL} = 18 \text{ mA}$	2.3		0.6	V
		$I_{OL} = 100 \mu A$	1.65 - 2.3		0.2	
		$I_{OL} = 6 \text{ mA}$	1.65		0.3	
		$I_{OL} = 100 \mu A$	1.4 - 1.6		0.2	
		$I_{OL} = 2 \text{ mA}$	1.4		0.35	
		$I_{OL} = 100 \mu A$	1.2		0.05	
l <sub>l</sub>	Input Leakage Current	$0 \leq V_I \leq 3.6V$	1.2 - 3.6		±5.0	μА
l <sub>OFF</sub>	Power-OFF Leakage Current	$0 \le (V_I, V_O) \le 3.6V$	0		10	μА
Icc	Quiescent Supply Current	V <sub>I</sub> = V <sub>CC</sub> or GND	1.2 - 3.6		20	^
		$V_{CC} \leq (V_I)$	1.2 - 3.6		±20	μА
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	$V_{IH} = V_{CC} - 0.6V$	2.7 - 3.6		750	μА

## AC Electrical Characteristics (Note 5)

Symbol	Parameter	Conditions	v <sub>cc</sub>	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Figure
			(V)	Min	Max	Oillio	Number
t <sub>PHL</sub>	Propagation Delay	$C_L = 30 \text{ pF}, R_L = 500\Omega$	$3.3 \pm 0.3$	0.6	3.0		F:
t <sub>PLH</sub>			$2.5\pm0.2$	8.0	3.9		Figures 1, 2
			$1.8\pm0.15$	1.0	7.8	ns	-, -
		$C_L = 15 \text{ pF}, R_L = 2k\Omega$	$1.5\pm0.1$	1.0	15.6		Figures
			1.2	1.5	39		3, 4
toshl	Output to Output Skew	$C_L = 30 \text{ pF}, R_L = 500\Omega$	$3.3 \pm 0.3$		0.5		
toslh	(Note 6)		$2.5\pm0.2$		0.5		
			$1.8\pm0.15$		0.75	ns	
		$C_L = 15 \text{ pF}, R_L = 2k\Omega$	$1.5 \pm 0.1$		1.5		
			1.2		1.5		

Note 5: For  $C_L = 50_P F$ , add approximately 300 ps to the AC maximum specification.

Note 6: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

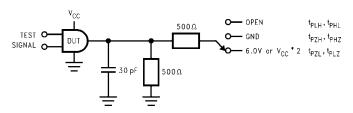
## **Dynamic Switching Characteristics**

Symbol	Parameter	Conditions	V <sub>CC</sub>	$T_A = +25^{\circ}C$	Units
		Conditions	(V)	Typical	Oints
V <sub>OLP</sub>	Quiet Output Dynamic Peak V <sub>OL</sub>	$C_L = 30 \text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0V$	1.8	0.25	
			2.5	0.6	V
			3.3	0.8	
V <sub>OLV</sub>	Quiet Output Dynamic Valley V <sub>OL</sub>	$C_L = 30 \text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0V$	1.8	-0.25	
			2.5	-0.6	V
			3.3	-0.8	
V <sub>OHV</sub>	Quiet Output Dynamic Valley VOH	$C_L = 30 \text{ pF}, V_{IH} = V_{CC}, V_{IL} = 0V$	1.8	1.5	
			2.5	1.9	V
			3.3	2.2	

## Capacitance

Symbol	Parameter	Conditions	T <sub>A</sub> = +25°C Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_{CC} = 1.8, 2.5 V \text{ or } 3.3 V, V_I = 0 V \text{ or } V_{CC}$	6	pF
C <sub>OUT</sub>	Output Capacitance	$V_{I} = 0V \text{ or } V_{CC}, V_{CC} = 1.8V, 2.5V \text{ or } 3.3V$	7	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_{I} = 0V \text{ or } V_{CC}, f = 10 \text{ MHz}, V_{CC} = 1.8V, 2.5V \text{ or } 3.3V$	20	pF

## AC Loading and Waveforms (V $_{CC}$ 3.3V $\pm$ 0.3V to 1.8V $\pm$ 0.15V)



TEST	SWITCH	
t <sub>PLH</sub> , t <sub>PHL</sub>	Open	
	FIGURE 4. AC Tool Circuit	

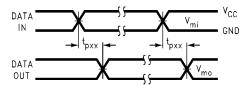
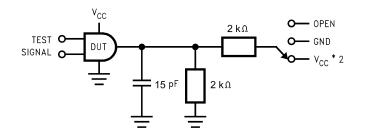


FIGURE 2. Waveform for Inverting and Non-Inverting Functions

Symbol	V <sub>CC</sub>				
- Cymbol	3.3V ± 0.3V	2.5V ± 0.2V	1.8V ± 0.15V		
V <sub>mi</sub>	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2		
V <sub>mo</sub>	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2		

## AC Loading and Waveforms (V $_{CC}$ 1.5V $\pm$ 0.1V to 1.2V)



ΨZΗ,	ЪНZ
t <sub>PZL</sub> ,	t <sub>PLZ</sub>

 ${}^{t_{\mathsf{PLH}}}, {}^{t_{\mathsf{PHL}}}$ 

TEST	SWITCH
$t_{PLH}$ , $t_{PHL}$	Open
$t_{PZL}, t_{PLZ}$	$V_{CC}$ x 2 at $V_{CC}$ = 1.5 ± 0.1V
$t_{PZH}, t_{PHZ}$	GND

FIGURE 3. AC Test Circuit

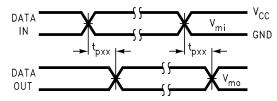


FIGURE 4. Waveform for Inverting and Non-Inverting Functions

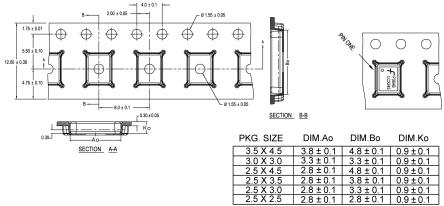
Symbol	v <sub>cc</sub>		
	1.5V ± 0.1V		
V <sub>mi</sub>	V <sub>CC</sub> /2		
V <sub>mo</sub>	V <sub>CC</sub> /2		

### **Tape and Reel Specification**

Tape Format for DQFN

Package Tape		Number	Cavity	Cover Tape	
Designator	Section	Cavities	Status	Status	
	Leader (Start End)	125 (typ)	Empty	Sealed	
BQX	Carrier	2500/3000	Filled	Sealed	
	Trailer (Hub End)	75 (typ)	Empty	Sealed	

#### TAPE DIMENSIONS inches (millimeters)



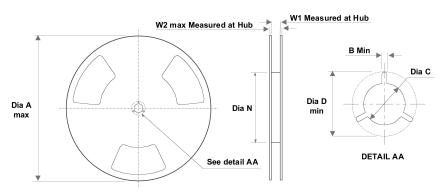
DIMENSIONS ARE IN MILLIMETERS

#### NOTES: unless otherwise specified

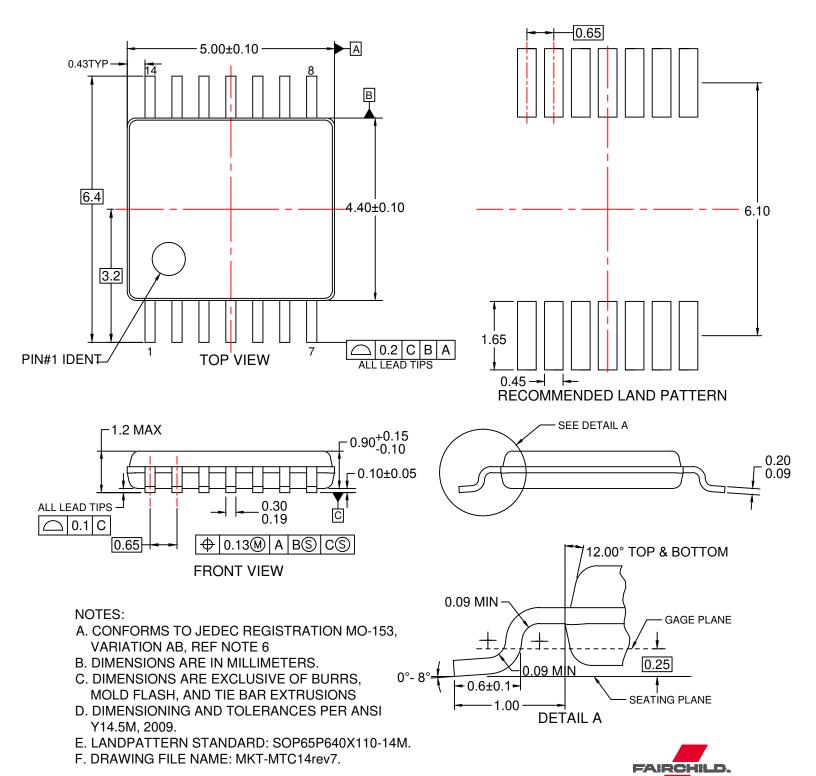
- 1. Cummulative pitch for feeding holes and cavities (chip pockets) not to exceed 0.008[0.20] over 10 pitch span.

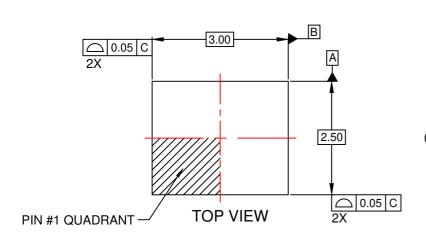
- 2. Smallest allowable bending radius.
  3. Thru hole inside cavity is centered within cavity.
  4. Tolerance is ±0.002[0.05] for these dimensions on all 12mm tapes.
  5. Ao and Bo measured on a plane 0.120[0.30] above the bottom of the pocket.
- 6. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
  7. Pocket position relative to sprocket hole measured as true position of pocket. Not pocket hole.
- 8. Controlling dimension is millimeter. Diemension in inches rounded.

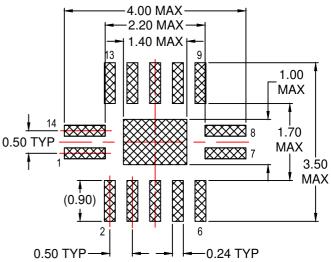
#### **REEL DIMENSIONS** inches (millimeters)

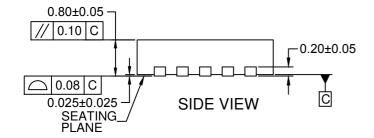


Tape Size	Α	В	С	D	N	W1	W2
12 mm	13.0	0.059	0.512	0.795	7.008	0.488	0.724
	(330)	(1.50)	(13.00)	(20.20)	(178)	(12.4)	(18.4)

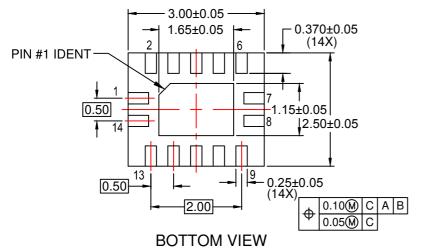








### RECOMMENDED LAND PATTERN



#### NOTES:

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- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
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